Electronic Patent Application Fee Transmittal							
Application Number:	10500196						
Filing Date:	10-Oct-2006						
Title of Invention:	Method and zone for sealing between two microstructure substrates						
First Named Inventor/Applicant Name:	Bernard Diem						
Filer:	Jasper W. Dockrey/Christine Pisarski						
Attorney Docket Number:	9905/23						
Filed as Large Entity	•						
U.S. National Stage under 35 USC 371 Filing	Fees						
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Submission-Information Disclosure Stmt	1806	1	180	180				
	Tot	180						